



DMN3009SFG

Product Summary

| BV _{DSS} | Rds(on) Max | I⊳ Max Tc = +25°C | |
|-------------------|-------------------------------|----------------------|--|
| | 5.5mΩ @ V _{GS} = 10V | 45A | |
| 30V | 9mΩ @ V _{GS} = 4.5V | 30A | |

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Power Management Functions
- DC-DC Converters
- Battery

30V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

https://www.diodes.com/products/automotive/automotiveproducts/.

- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.
- https://www.diodes.com/quality/product-definitions/
- An Automotive-Compliant Part is Available Under Separate
 Datasheet (DMN3009SFGQ)

Mechanical Data

- Case: PowerDI[®]3333-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.072 grams (Approximate)

PowerDI3333-8



Ordering Information (Note 4)

| | Part Number | Case | Packaging |
|---|--------------|---------------|-------------------|
| | DMN3009SFG-7 | PowerDI3333-8 | 2,000/Tape & Reel |
| DMN3009SFG-13 PowerDI3333-8 3,000/Tape & Reel | | | |

No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</p>

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



N09= Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 21 = 2021) WW = Week Code (01 to 53)

PowerDI is a registered trademark of Diodes Incorporated.



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit | |
|--|------------------------|----------------|------|---|
| Drain-Source Voltage | Vdss | 30 | V | |
| Gate-Source Voltage | Vgss | ±20 | V | |
| | T _A = +25°C | | 16 | А |
| | $T_A = +70^{\circ}C$ | I _D | 13 | |
| Continuous Drain Current, V _{GS} = 10V (Note 6) | Tc = +25°C | | 45 | А |
| | Tc = +70°C | ID | 35 | |
| Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%) | Ідм | 80 | А | |
| Maximum Continuous Body Diode Forward Current (Note 6) | ls | 20 | А | |
| Avalanche Current, L = 0.1mH | las | 33 | А | |
| Avalanche Energy, L = 0.1mH | Eas | 55 | mJ | |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit | | |
|--|------------------------|------------------|------|------|--|
| Total Dower Dissinction (Note 5) | T _A = +25°C | D- | 0.9 | W | |
| Total Power Dissipation (Note 5) | T _A = +70°C | PD | 0.6 | | |
| Thermal Resistance, Junction to Ambient (Note 5) | R _{0JA} | 137 | °C/W | | |
| Total Dower Dissinction (Nate C) | T _A = +25°C | Po | 2.1 | W | |
| Total Power Dissipation (Note 6) | T _A = +70°C | гD | 1.4 | vv | |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady State | R _{0JA} | 59 | °C/W | |
| Thermal Resistance, Junction to Case (Note 6) | R _{θJC} | 7.8 | °C/W | | |
| Operating and Storage Temperature Range | TJ, TSTG | -55 to +150 | °C | | |

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

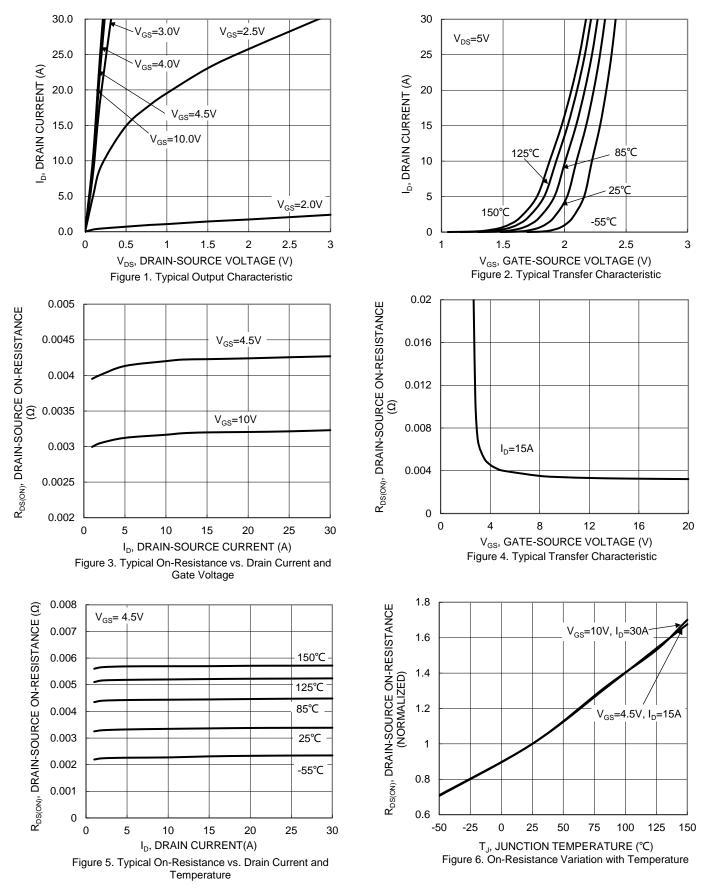
| Characteristic | Symbol | Min | Turn | Мах | Unit | Test Condition | |
|--|--------------------|--------|-------|------|-------|--|--|
| | Symbol | IVIIII | Тур | Widx | Unit | Test condition | |
| OFF CHARACTERISTICS (Note 6) | | | 1 | | | | |
| Drain-Source Breakdown Voltage | BVDSS | 30 | — | — | V | Vgs = 0V, ID = 250µA | |
| Zero Gate Voltage Drain Current | IDSS | — | — | 1 | μA | $V_{DS} = 24V, V_{GS} = 0V$ | |
| Gate-Source Leakage | lgss | _ | — | ±100 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 6) | | | | | | | |
| Gate Threshold Voltage | VGS(TH) | 1 | — | 2.5 | V | $V_{DS} = V_{GS}$, $I_D = 250 \mu A$ | |
| Static Drain-Source On-Resistance | Descent | _ | 3.4 | 5.5 | mΩ | Vgs = 10V, ID = 20A | |
| | Rds(on) | | 4.4 | 9 | 11152 | V _{GS} = 4.5V, I _D = 16A | |
| Diode Forward Voltage | V _{SD} | | 0.7 | 1 | V | $V_{GS} = 0V, I_S = 1A$ | |
| DYNAMIC CHARACTERISTICS (Note 7) | | | | | | | |
| Input Capacitance | Ciss | _ | 2,000 | | pF | | |
| Output Capacitance | Coss | _ | 315 | | pF | − V _{DS} = 15V, V _{GS} = 0V, − f = 1MHz | |
| Reverse Transfer Capacitance | Crss | _ | 248 | | pF | | |
| Gate Resistance | Rg | _ | 2.2 | _ | Ω | $V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$ | |
| Total Gate Charge (V _{GS} = 4.5V) | Qg | _ | 20 | _ | nC | | |
| Total Gate Charge (V _{GS} = 10V) | Qg | | 42 | _ | nC | | |
| Gate-Source Charge | Q _{gs} | _ | 4.7 | _ | nC | VDS = 15V, ID = 15A | |
| Gate-Drain Charge | Q _{gd} | _ | 7.4 | _ | nC | | |
| Turn-On Delay Time | t _{D(ON)} | — | 3.9 | _ | ns | | |
| Turn-On Rise Time | tR | _ | 4.1 | _ | ns | V _{DD} = 15V, V _{GS} = 10V, | |
| Turn-Off Delay Time | tD(OFF) | _ | 31 | | ns | R _G = 3.3Ω, I _D = 15A | |
| Turn-Off Fall Time | tF | _ | 14.6 | | ns | 7 | |
| Reverse Recovery Time | t _{RR} | | 15 | | ns | | |
| Reverse Recovery Charge | Qrr | | 6 | _ | nC | I _F = 15A, di/dt = 100A/μs | |

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect. Notes:

DMN3009SFG Document number: DS36747 Rev. 7 - 2

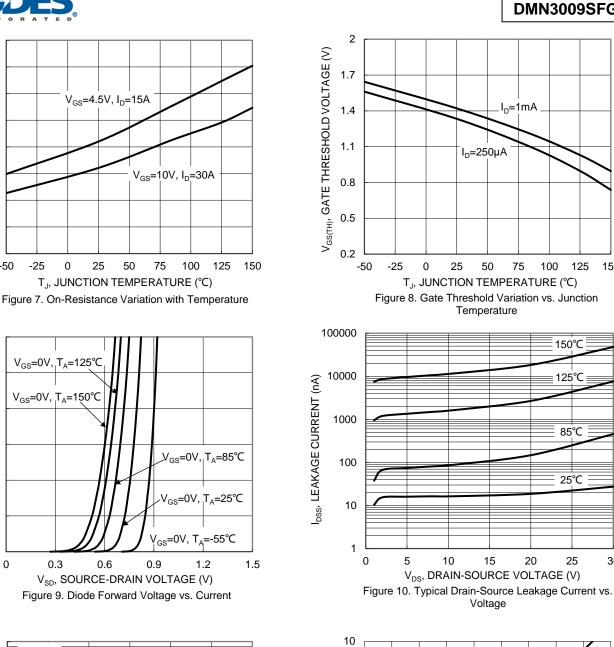


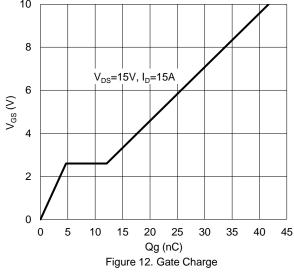
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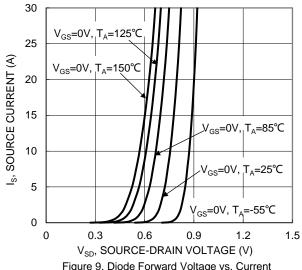
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0.008 R_{DS(ON)}, DRAIN-SOURCE ON-RESISTANCE 0.007 0.006 0.005 g 0.004 0.003 0.002 0.001 0 -50 -25 T_., JUNCTION TEMPERATURE (°C)



10000 f=1MHz C_T, JUNCTION CAPACITANCE (pF) $\mathbf{C}_{\mathrm{iss}}$ 1000 C_{oss} $\mathbf{C}_{\mathrm{rss}}$ 100 0 10 20 5 15 25 30 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 11. Typical Junction Capacitance

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I_D=1mA

75

100

125

150[°]C

125°C

85°℃

25℃

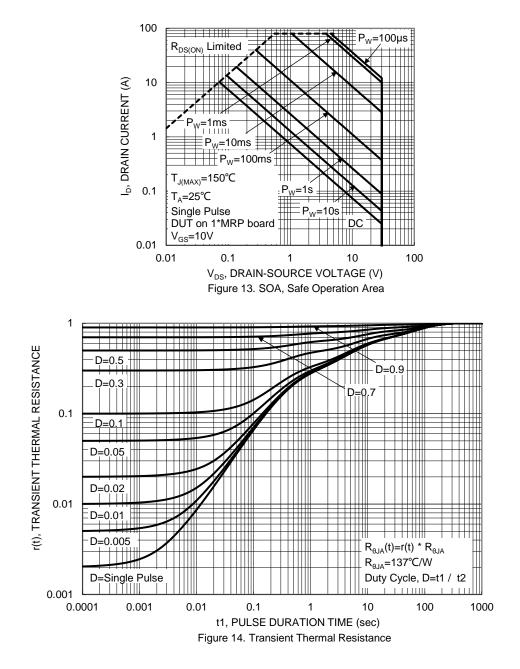
25

30

20

150

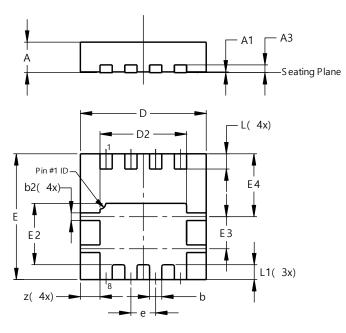






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

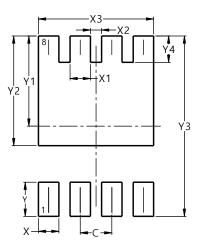


| PowerDI3333-8 | | | | | |
|---------------|----------------------|------|-------|--|--|
| Dim | Min | Max | Тур | | |
| Α | 0.75 | 0.85 | 0.80 | | |
| A1 | 0.00 | 0.05 | 0.02 | | |
| A3 | _ | _ | 0.203 | | |
| b | 0.27 | 0.37 | 0.32 | | |
| b2 | 0.15 | 0.25 | 0.20 | | |
| D | 3.25 | 3.35 | 3.30 | | |
| D2 | 2.22 | 2.32 | 2.27 | | |
| Е | 3.25 | 3.35 | 3.30 | | |
| E2 | 1.56 | 1.66 | 1.61 | | |
| E3 | 0.79 | 0.89 | 0.84 | | |
| E4 | 1.60 | 1.70 | 1.65 | | |
| е | - | - | 0.65 | | |
| L | 0.35 | 0.45 | 0.40 | | |
| L1 | _ | _ | 0.39 | | |
| z | _ | _ | 0.515 | | |
| All I | All Dimensions in mm | | | | |

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

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| Dimensions | Value (in mm) |
|------------|---------------|
| С | 0.650 |
| Х | 0.420 |
| X1 | 0.420 |
| X2 | 0.230 |
| X3 | 2.370 |
| Y | 0.700 |
| Y1 | 1.850 |
| Y2 | 2.250 |
| Y3 | 3.700 |
| Y4 | 0.540 |

PowerDI3333-8



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